

## **Product Change Notice**

Doc. No.: RF-008-0002

Revision: E

# PCN-200917-05 C19\_070\_8 inch BSI products change from laser anneal process to High-K process \_TSMC (OV6946/OVM6946)

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## **Product Change Notice**

PCN Number	200917-05	PCN Date	Jan-31, 2021	Effective Date	April-31, 2021
PCN Revision	0				
Title	TSMC 8 inch BSI products change from laser anneal process to High-K process				
<b>Customer Contact</b>	OV06946, OVM6946 customers				
<b>Proposed Ship Date</b>		TBD		Sample Available date	available

#### **PCN Details**

#### **Description of Change**

- TSMC 8 inch BSI products to change from Laser anneal process to High-K process.
- TSMC will phase out 8 inch laser anneal tool due to tool vendor end of service.
- New part# with High-K

OVM6946-RAJA → OVM6946-RAJA-1B (with High-K)

OVM6946-RAJH → OVM6946-RAJH-1B (with High-K)

OVM6946-RAJH-R1 → OVM6946-RAJH-1C (with High-K)

OVM6946-RANA → OVM6946-RANA-1B (with High-K)

OV06946-xxxx-xx  $\rightarrow$  OV06946-xxxx-1D (with High-K)

#### **Reason for Change**

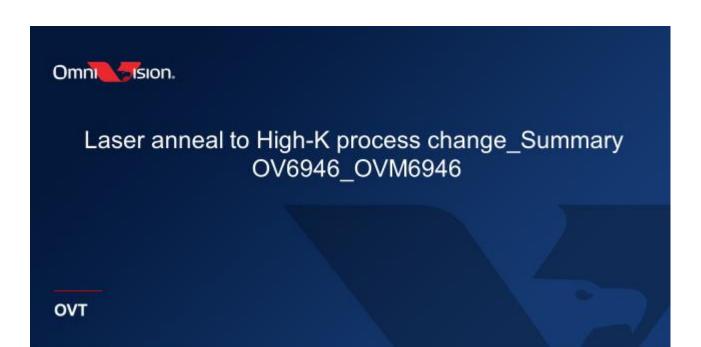
Laser tool phase out at TSMC

<b>Product Affected</b>	OV06946-xxxx-xx; OVM6946-xxxx-xx;

#### **Addition Information**

8 inch BSI products from Laser to High-K\_Summary (PCN)

Notes: Customer should acknowledge receipt of PCN within 30 days. Lack of acknowledgement within 30 days constitutes change acceptance.



January 31, 2021

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- New part# with High-K

OVM6946-RAJA → OVM6946-RAJA-1B (with High-K)

OVM6946-RAJH → OVM6946-RAJH-1B (with High-K)

OVM6946-RAJH-R1 → OVM6946-RAJH-1C (with High-K)

OVM6946-RANA → OVM6946-RANA-1B (with High-K)

 ${\rm OV06946\text{-}xxxx\text{-}xx} \rightarrow {\rm OV06946\text{-}xxxx\text{-}1D(with High\text{-}K)}$ 

#### Quality Plan:

- Reliability Qualification. (completed by Feb, 2021)

#### Product Affected:

- OVM6946-xxxx-xx
- OV06946-xxxx-xx

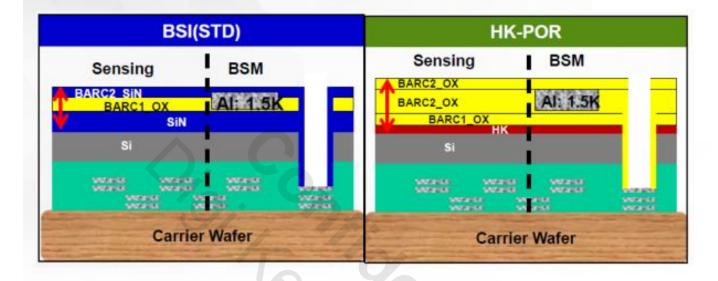


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#### What is changing?

- > TSMC 8 inch BSI products to change from 'Laser anneal' process to 'High-K' process.
- > TSMC will phase out 8" inch laser anneal tool due to tool vendor end of service.

### Process change details





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# **Performance Summary**

High-K over Laser anneal process (see page below for data)

- > Better White Pixel performance
- > Color Ratio and Color Shading are comparable
- > Image mean values were shifted

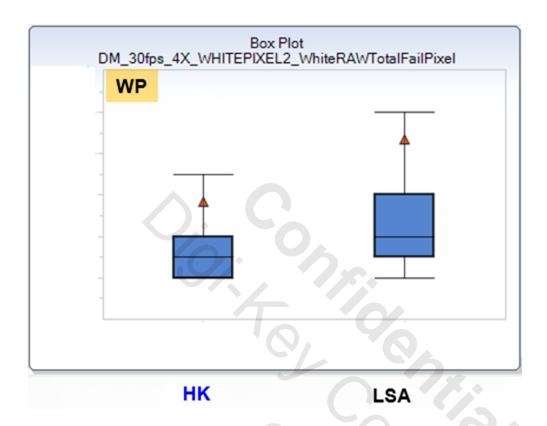
# Summary

- > Customers can work with FAE if need to fine tune the ISP
- > Customer high-K material samples will be available on request



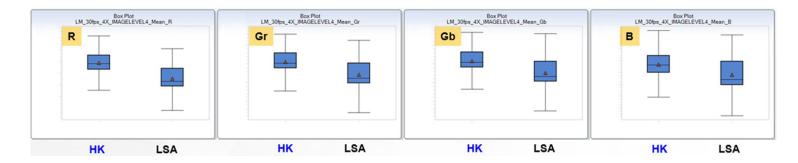
# **WP**

> WP of High-K material are better than the laser anneal process.



## Image level mean

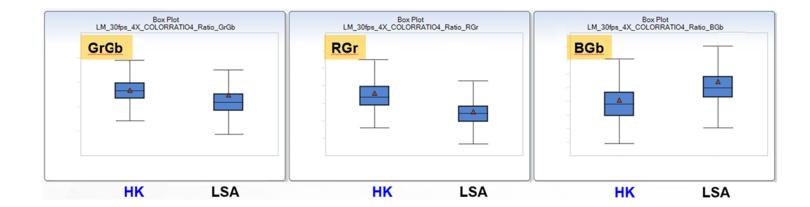
➤ Image level mean of High-K material are higher (~7%) than Laser anneal process.





## **Color Ratio**

> Color ratio of high-K material are comparable with Laser anneal process.



## **Color Shading: CS25ROI**

> Color shading of high-K material are comparable with Laser anneal process.

